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U.S. Department of Commerce
Patent and Trademark Office



103453105

To the Honorable Commissioner of Patents and Trademarks. Please record the attached original documents or copy thereof.

1. Name of Conveying Party:

- 1) Weijia WEN
- 2) Ping SHENG
- 3) Xize NIU
- 4) Liyu LIU

G Additional names of conveying parties attached.

2. Name and Address of Receiving Party(ies):

Name: THE HONG KONG UNIVERSITY OF
SCIENCE AND TECHNOLOGY

Street Address: Clear Water Bay, Kowloon

City, State, Zip: Hong Kong, China

G Additional name(s) and address(es) attached.

3. Nature of Conveyance

☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other:

Execution Date: 1) September 26, 2007
2) October 2, 2007 3) September 27, 2007
4) September 26, 2007

4. (A) Patent Application Number(s):

If this document is being filed together with a new application,
the execution date of the application is:

- 1) September 26, 2007
- 2) October 2, 2007 3) September 27, 2007
- 4) September 26, 2007

Additional Numbers Attached.

4. (B) Patent Number(s):

5. Name and Address of Party to whom Correspondence
Concerning this Document Should be Mailed:

Name: Gary M. Nath

Address: CUSTOMER NO. 20529
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6. Total Number of Applications and Patents Involved:

1

7. Total Fee:

(37 CFR 3.41)

\$ 40.00

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X Authorized to be charged to deposit account any deficiency or
credit any excess..

8. Deposit Account Number:

14-0112

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9. Statement and Signature:

To the best of my knowledge and belief, the foregoing is true and correct and any attached
copy is a true copy of the original document.

Name of Person Signing

Gary M. Nath, Reg. No. 26,965
Jerald L. Meyer, Reg. No. 41,194
Customer No. 20529

Date: October 4, 2007

Attorney Docket No.: 286001

Total number of pages comprising cover sheet: 1

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PATENT
REEL: 019980 FRAME: 0025

ASSIGNMENT

FOR GOOD AND VALUABLE CONSIDERATION given to **WeiJia WEN, Ping SHENG, Xize NIU** and **Liyu LIU**, hereinafter referred to as the ASSIGNOR(S), who has/have invented certain new and useful **CONSTRUCTING PLANAR AND THREE-DIMENSIONAL MICROSTRUCTURES WITH PMDS-BASED CONDUCTING COMPOSITE**, hereinafter referred to as the invention, for which I/we has/have executed an application for Letters Patent to be filed in the United States Patent and Trademark Office.

WHEREAS, **THE HONG KONG UNIVERSITY OF SCIENCE AND TECHNOLOGY**, a corporation organized and existing under the laws of the country/state of **China**, whose post office address/business address is **Clear Water Bay, Kowloon, Hong Kong, China**, hereinafter referred to as the ASSIGNEE, desires to acquire the entire right, title and interest for the United States and elsewhere throughout the world in and to said invention and application, including any and all divisions and continuations thereof, all rights of priority under the terms of the International Convention for the Protection of Industrial Property, and any and all Letters Patent which may be granted thereon, including any and all renewals, reissues and prolongations thereof.

NOW, WITNESSETH THIS that for and in consideration of the sum of one dollar (\$1.00) and other good and valuable consideration, the receipt, adequacy and sufficiency of which are hereby acknowledged, said ASSIGNOR(S) hereby assign(s), sell(s) and transfer(s) to said ASSIGNEE, its assigns and legal representatives, the entire right, title and interest for the United States and elsewhere throughout the world, in and to said invention and application, including any and all divisions and continuations thereof, all rights of priority under the terms of the International Convention for the Protection of Industrial Property, and any and all Letters Patent which may be granted thereon, including any and all renewals, reissues and prolongations thereof, with all the rights, powers, privileges, and advantages in any way arising from or pertaining thereto, for and during the term or terms of any and all such Letters Patent when granted, including any and all renewals, reissues and prolongations thereof, for the use and benefit of said ASSIGNEE and its assigns and legal representatives, in as ample and as beneficial a manner for all intents and purposes as said ASSIGNOR(S) might or could have held and enjoyed the same had this assignment not been made.

ASSIGNMENT

ALSO, said ASSIGNOR(S) hereby agree(s) to execute all papers necessary to file said applications in the United States and elsewhere throughout the world, and to assign the same to said ASSIGNEE, or any assignee acquiring title to said invention, and to execute any other papers that may be needed in connection with filing said application and securing any and all Letters Patent thereon.

AND said ASSIGNOR(S) authorize(s) and request(s) the Commissioner of Patents to issue a Letters Patent on said application, and on any and all divisions and continuations thereof, to said ASSIGNEE, its assigns and legal representatives, in accordance herewith.

By: Wen Weijia
Inventor's Name: **WeiJia WEN**
(first or first inventor)

26/09/2007
Date

By: Ping Sheng
Inventor's Name: **Ping SHENG**
(second inventor)

2/10/2007
Date

By: _____
Inventor's Name: **Xize NIU**
(third inventor)

Date

By: Liyu
Inventor's Name: **Liyu LIU**
(fourth inventor)

26/09/2007
Date

ASSIGNMENT

ALSO, said ASSIGNOR(S) hereby agree(s) to execute all papers necessary to file said applications in the United States and elsewhere throughout the world, and to assign the same to said ASSIGNEE, or any assignee acquiring title to said invention, and to execute any other papers that may be needed in connection with filing said application and securing any and all Letters Patent thereon.

AND said ASSIGNOR(S) authorize(s) and request(s) the Commissioner of Patents to issue a Letters Patent on said application, and on any and all divisions and continuations thereof, to said ASSIGNEE, its assigns and legal representatives, in accordance herewith.

By: _____
Inventor's Name: **WeiJia WEN**
(first or first inventor)

Date

By: _____
Inventor's Name: **Ping SHENG**
(second inventor)

Date

By: *Xiuzi*
Inventor's Name: **Xize NIU**
(third inventor)

27 / 09 / 2007
Date

By: _____
Inventor's Name: **Liyu LIU**
(fourth inventor)

Date